

30V N-Channel Enhancement Mode MOSFET

Description

The AP100N03D uses advanced trench technology

to provide excellent R_{DS(ON)}, low gate charge and

operation with gate voltages as low as 4.5V. This

device is suitable for use as a

Battery protection or in other Switching application.

General Features

V_{DS} = 30V I_D =100 A

 $R_{DS(ON)} < 5.5m\Omega @ V_{GS}=10V (Type: 3.6m\Omega)$

Application

Battery protection

Load switch

Uninterruptible power supply

imes use or Package Marking and Ordering Information

Product ID		Pack	Marking	Qty(PCS)
AP100N03D	Nr.	TO-252-3L	AP100N03D XXX YYYY	2500

Absolute Maximum Ratings (Tc=25°Cunless otherwise noted)

Symbol	Parameter	Max.	Units
VDSS 🔨	Drain-Source Voltage	30	V
VGSS	Gate-Source Voltage	±20	V
l₀@Tc=25℃	Continuous Drain Current, V _{GS} @ 10V	100	А
I ⊳@Tc=100 ℃	Continuous Drain Current, V _{GS} @ 10V	59	А
IDM	Pulsed Drain Current note1	360	А
EAS	Single Pulsed Avalanche Energy note2	95	mJ
IAS	Avalanche Current	19.5	А
P₀@Tc=25℃	Total Power Dissipation ⁴	68	W
R₀JA	Thermal Resistance Junction-ambient (Steady State) ¹	62	°C <i>I</i> W
R₀JA	Thermal Resistance Junction-Ambient 1 (t ≤10s)	25	°C /W
RθJC	Thermal Resistance, Junction to Case	2.2	°C/W
TJ, TSTG	Operating and Storage Temperature Range	-55 to +175	°C







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Symbol	Parameter	Test Condition	Min.	Тур.	Max.	Units
V(BR)DSS	Drain-Source Breakdown Voltage V _{GS} =0V, I _D =250µA		30	32	-	V
$\triangle BVDSS / \triangle TJ$	BVDSS Temperature Coefficient	Reference to 25°C, ID=1mA		0.028		V/°C
VGS(th)	Gate Threshold Voltage	V _{DS} = V _{GS} , I _D =250µA	1.0	1.6	2.5	V
RDS(on)	Static Drain-Source on-Resistance note3	V _{GS} =10V, I _D =30A	-	3.6	5.5	mΩ
RDS(on)	Static Drain-Source on-Resistance note3	V _{GS} =4.5V, I _D =20A	-	6.7	9.5	mΩ
IDSS	Zero Gate Voltage Drain Current	V _{DS} =30V, V _{GS} = 0V,	-	-	1.0	μA
IGSS	Gate to Body Leakage Current	V _{DS} =0V, V _{GS} = ±20V	-	-	±100	nA
Ciss	Input Capacitance		7	2100	-	pF
Coss	Output Capacitance	V _{DS} =15V, V _{GS} =0V, f = 1.0MHz	-	326	-	pF
Crss	Reverse Transfer Capacitance		-	282	-	pF
Qg	Total Gate Charge		-	45	-	nC
Qgs	Gate-Source Charge	V _{DS} =15V, J _D =30A, V _{GS} =10V	-	3	-	nC
Q_gd	Gate-Drain("Miller") Charge		-	15	-	nC
td(on)	Turn-on Delay Time		-	21	-	ns
tr	Turn-on Rise Time $V_{DS}=15V$, $I_D=30A$, $R_{GEN}=3\Omega$,		-	32	-	ns
td(off)	Turn-off Delay Time	$V_{GS} = 10V$	-	59	-	ns
t _f	Turn-off Fall Time		-	34	-	ns
IS	Maximum Continuous Drain to Source Diode Forward Current		-	-	90	А
ISM	Maximum Pulsed Drain to Source Diode Forward Current		-	-	360	А
VSD	Drain to Source Diode Forward Voltage	V _{GS} = 0V, I _S =30A	-	-	1.2	V
trr	Body Diode Reverse Recovery Time	covery Time		15	-	ns
Qrr	Body Diode Reverse Recovery Charge	l _F =20A,dI/dt=100A/µs	-	4	-	nC
Notos:			l		l	

Electrical Characteristics (TJ=25°C, unless otherwise noted)

Notes:

1、 Repetitive Rating: Pulse Width Limited by Maximum Junction Temperature

2、 The test condition is, VDD =15V, VG =10V, RG =25 Ω , L=0.5mH, IAS =19.5A

3、The data tested by pulsed Pulse Test: Pulse Width≤300µs, Duty Cycle≤0.5%

4、The power dissipation is limited by 150°C junction temperature



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Figure 6: Capacitance Characteristics

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Package Mechanical Data: TO-252-3L



	Dimensions					
Ref.	Millimeters		Inches			
	Min.	Тур.	Max.	Min.	Тур.	Max.
Α	2.10		2.50	0.083		0.098
A2	0		0.10	0		0.004
В	0.66		0.86	0.026		0.034
B2	5.18		5.48	0.202		0.216
С	0.40		0.60	0.016		0.024
C2	0.44		0.58	0.017		0.023
D	5.90		6.30	0.232		0.248
D1	5.30REF			0.209REF		
E	6.40		6.80	0.252		0.268
E1	4.63	2.		0.182		
G	4.47		4.67	0.176		0.184
н	9.50		10.70	0.374		0.421
L	1.09		1.21	0.043		0.048
2	1.35		1.65	0.053		0.065
V1		7°			7°	
V2	0°		6°	0°		6°

Reel Spectification-TO-252

TO-252



	Dimensions					
Ref.	Millimeters			Inches		
	Min.	Тур.	Max.	Min.	Тур.	Max.
W	15.90	16.00	16.10	0.626	0.630	0.634
E	1.65	1.75	1.85	0.065	0.069	0.073
F	7.40	7.50	7.60	0.291	0.295	0.299
D0	1.40	1.50	1.60	0.055	0.059	0.063
D1	1.40	1.50	1.60	0.055	0.059	0.063
P0	3.90	4.00	4.10	0.154	0.157	0.161
P1	7.90	8.00	8.10	0.311	0.315	0.319
P2	1.90	2.00	2.10	0.075	0.079	0.083
A0	6.85	6.90	7.00	0.270	0.271	0.276
B0	10.45	10.50	10.60	0.411	0.413	0.417
K0	2.68	2.78	2.88	0.105	0.109	0.113
Т	0.24		0.27	0.009		0.011
t1	0.10			0.004		
10P0	39.80	40.00	40.20	1.567	1.575	1.583

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Edition	Date	Change
Rve3.8	2018/1/31	Initial release
Rve3.9	2019/12/01	Reduce RDS(on)
Rve4.0	2020/5/02	Change of specification format

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Test Report For 30PCS (30pcs 典型測試報告)



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